

P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	R _{DS(ON)} Max	I _D Max T _C = +25°C		
-12V	11.7mΩ @ V _{GS} = -4.5V	-19A		
-12V	$18.6 \text{m}\Omega$ @ $V_{GS} = -2.5 \text{V}$	-15A		

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications. It is qualified to AEC-Q101, supported by a PPAP.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

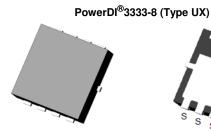
- Low RDS(ON) Ensures On-State Losses are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- ESD Protected Up to 3kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP1011LFVQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

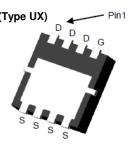
https://www.diodes.com/quality/product-definitions/

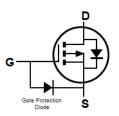
Mechanical Data

- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: 0.072 grams (Approximate)









Top View

Bottom View Pin Configuration

Equivalent Circuit

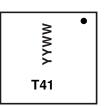
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP1011LFVQ-7	PowerDI [®] 3333-8 (Type UX)	2,000/Tape & Reel
DMP1011LFVQ-13	PowerDI [®] 3333-8 (Type UX)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



T41 = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 21 for 2021)
WW = Week Code 01 to 53



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-12	V
Gate-Source Voltage			V _{GSS}	- 6	V
Continuous Drain Current (Note C) V 4 EV	t < 10s	T _A = +25°C T _A = +70°C	lo	-13 -10	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	$T_C = +25^{\circ}C$ $T_C = +70^{\circ}C$	lo	-19 -15	А
Maximum Continuous Body Diode Forward Current (Note 6)			Is	3	Α
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)			I _{DM}	70	Α
Avalanche Current (Note 7) L = 0.3mH			I _{AS}	24	Α
Avalanche Energy (Note 7) L = 0.3mH			Eas	86	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	1.05	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	118	°C/W
Thermal nesistance, bunction to Ambient (Note 5)	t < 10s	МθЈА	83.5	
Total Power Dissipation (Note 6)		PD	2.16	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	ReJA	57	°C/W
Thermal nesistance, bunction to Ambient (Note 6)	t < 10s	HOJA	40.3	
Thermal Resistance, Junction to Case (Note 6)	Rejc	11.7		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

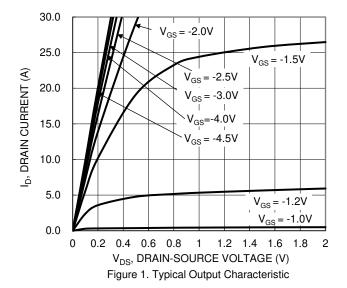
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-12	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_	_	-1	μΑ	V _{DS} = -9.6V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	-100	nA	$V_{GS} = -6V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)	•						
Gate Threshold Voltage	V _{GS(TH)}	-0.6	_	-1.2	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	PDC(ON)	_	9.8	11.7	mΩ	$V_{GS} = -4.5V$, $I_{D} = -12A$	
Static Drain-Source On-nesistance	RDS(ON)	_	14.6	18.6	11122	$V_{GS} = -2.5V$, $I_{D} = -9A$	
Diode Forward Voltage	V_{SD}	_	-0.8	-1.0	V	$V_{GS} = 0V, I_{S} = -16A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	913	_		V _{DS} = -6V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss		458	_	рF		
Reverse Transfer Capacitance	Crss	_	53				
Gate Resistance	Rg	_	1.85	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (VGS = -6V)	Qg	_	9.5	_			
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	7.1	_	nC	V _{DS} = -6V. I _D = -12A	
Gate-Source Charge	Qgs	_	1.4	_	IIC	VDS = -6V, ID = -12A	
Gate-Drain Charge	Qgd	_	1.1	_			
Turn-On Delay Time	t _{D(ON)}	_	6.3	_			
Turn-On Rise Time	tr	_	2.6	_		$V_{DS} = -6V, V_{GS} = -4.5V,$ $R_L = 1\Omega, R_g = 4.7\Omega, I_D = -12A$	
Turn-Off Delay Time	t _{D(OFF)}	_	14.4	_	ns		
Turn-Off Fall Time	t _F	_	3.9	_			
Body Diode Reverse Recovery Time	trr	_	13.5	_	ns	I _F = -12A, dI/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	2.5	_	nC	I _F = -12A, dI/dt = 100A/μs	

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
- 7. IAs and EAs ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to production testing.





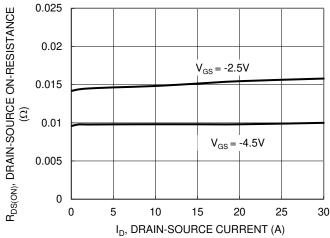


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

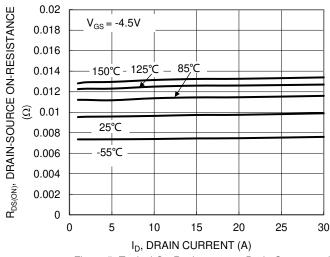
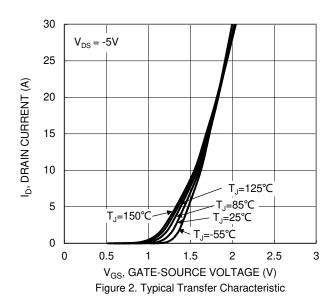


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



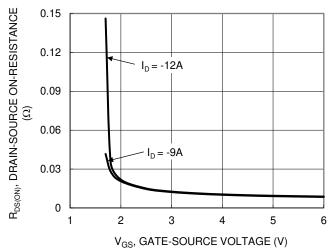


Figure 4. Typical Transfer Characteristic

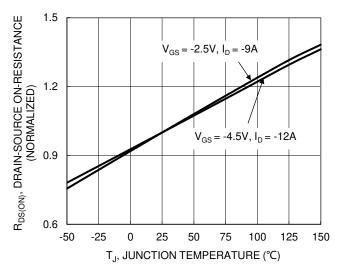


Figure 6. On-Resistance Variation with Temperature



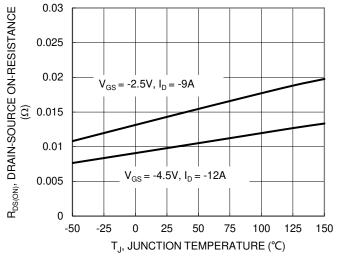


Figure 7. On-Resistance Variation with Temperature

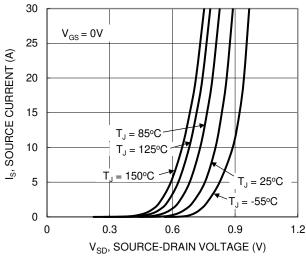


Figure 9. Diode Forward Voltage vs. Current

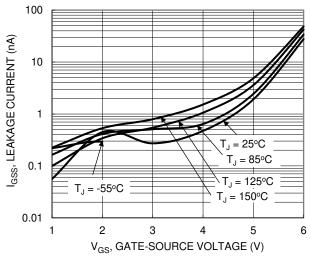


Figure 11. Gate-Source Leakage Current vs. Voltage

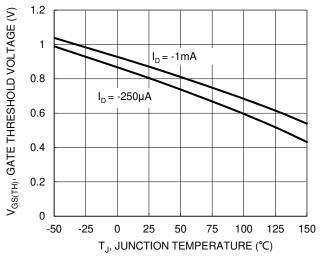


Figure 8. Gate Threshold Variation vs. Junciton Temperature

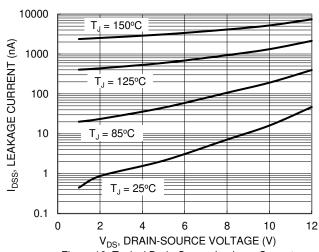


Figure 10. Typical Drain-Source Leakage Current vs.
Voltage

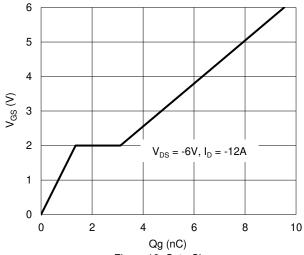
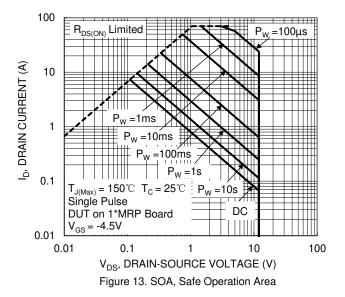


Figure 12. Gate Charge





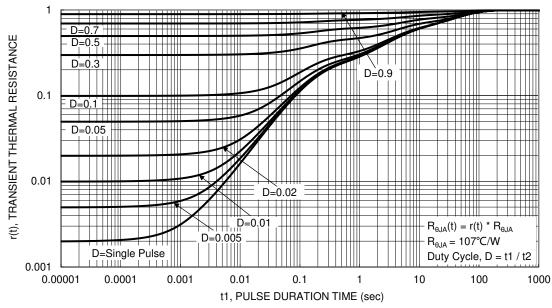


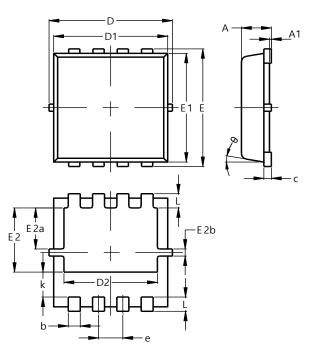
Figure 14. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI®3333-8 (Type UX)

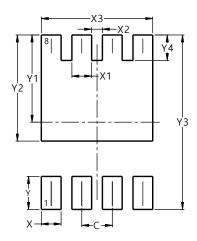


PowerDI3333-8 (Type UX)					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05			
b	0.25	0.40	0.32		
С	0.10	0.25	0.15		
D	3.20	3.40	3.30		
D1	2.95	3.15	3.05		
D2	2.30	2.70	2.50		
Е	3.20	3.40	3.30		
E1	2.95	3.15	3.05		
E2	1.60	2.00	1.80		
E2a	0.95	1.35	1.15		
E2b	0.10	0.30	0.20		
е	0.65 BSC				
k	0.50	0.90	0.70		
L	0.30	0.50	0.40		
θ	0°	12°	10°		
All Dimensions in mm					

Suggested Pad Layout

 $Please\ see\ http://www.diodes.com/package-outlines.html\ for\ the\ latest\ version.$

PowerDI®3333-8 (Type UX)



Dimensions	Value (in mm)		
С	0.650		
X	0.420		
X1	0.420		
X2	0.230		
Х3	2.370		
Υ	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		
Y4	0.540		



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